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a first substrate having an inner surface;
a second substrate having an inner surface;
a liquid-crystal layer disposed between said first and second substrates;
a wiring layer formed on at least one of said inner surfaces of said first and second substrates, said wiring layer including a connection portion;
a pixel electrode coupled to said connection portion of said wiring layer; and
an insulating film formed on a surface of said wiring layer.

9. (NEW) The liquid-crystal display device of Claim 8 wherein said insulating film is insulatingly disposed between said wiring layer and said pixel electrode.

10. (NEW) The liquid-crystal display device of Claim 9 wherein said insulating film includes an opening through which said pixel electrode is coupled to said wiring layer.

11. (NEW) The liquid-crystal display device of Claim 9 further comprising a MIM element coupled between said connection portion and said pixel electrode.

12. (NEW) The liquid-crystal display device of Claim 11 wherein said insulating film covers a surface of said MIM element.

13. (NEW) The liquid-crystal display device of Claim 8 further comprising a TFT element coupled between said connection portion and said pixel electrode.

14. (NEW) The liquid-crystal display device of Claim 13 wherein said insulating film is formed on said wiring layer connected to said TFT element.

15. (NEW) The liquid-crystal display device of Claim 8 wherein said insulating film has light shading properties.

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16. (NEW) A method of forming a liquid-crystal display device comprising:
providing a first substrate having an inner surface;
providing a second substrate having an inner surface;
forming a wiring layer on at least one of said inner surfaces of said first and second substrates;
forming an insulating film over a surface of said wiring layer;
forming a pixel electrode such that a peripheral portion thereof is arranged on said insulating film;
coupling said pixel electrode to a connection portion of said wiring layer; and
interposing a liquid crystal layer between said first and second substrates.

17. (NEW) The method of Claim 16 further comprising:
connecting a MIM element between said connection portion and said pixel electrode and forming said insulating film so as to cover a surface of said MIM element.

IN THE ABSTRACT

Page 23, line 14, please delete "(to be described later)".